

SEMiX452GAL126HDs



SEMiX[®] 2s

Trench IGBT Modules

SEMiX452GAL126HDs

Features

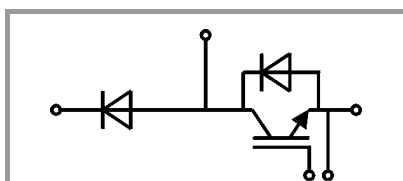
- Homogeneous Si
- Trench = Trenchgate technology
- $V_{CE(sat)}$ with positive temperature coefficient
- High short circuit capability
- UL recognised file no. E63532

Typical Applications*

- AC inverter drives
- UPS
- Electronic Welding

Remarks

- Case temperatur limited to $T_C=125^{\circ}C$ max.
- Not for new design



GAL

| Absolute Maximum Ratings | | | | | |
|---------------------------|---|----------------------|-------------|-------------|--|
| Symbol | Conditions | | Values | Unit | |
| IGBT | | | | | |
| V_{CES} | $T_j = 25^{\circ}C$ | | 1200 | V | |
| I_C | $T_j = 150^{\circ}C$ | $T_c = 25^{\circ}C$ | 455 | A | |
| | | $T_c = 80^{\circ}C$ | 319 | A | |
| I_{Cnom} | | | 300 | A | |
| I_{CRM} | $I_{CRM} = 2 \times I_{Cnom}$ | | 600 | A | |
| V_{GES} | | | -20 ... 20 | V | |
| t_{psc} | $V_{CC} = 600 V$ $V_{GE} \leq 20 V$ $V_{CES} \leq 1200 V$ | $T_j = 125^{\circ}C$ | 10 | μs | |
| | | | | | |
| T_j | | | -40 ... 150 | $^{\circ}C$ | |
| Inverse diode | | | | | |
| I_F | $T_j = 150^{\circ}C$ | $T_c = 25^{\circ}C$ | 394 | A | |
| | | $T_c = 80^{\circ}C$ | 272 | A | |
| I_{Fnom} | | | 300 | A | |
| I_{FRM} | $I_{FRM} = 2 \times I_{Fnom}$ | | 600 | A | |
| I_{FSM} | $t_p = 10 ms, \sin 180^{\circ}, T_j = 25^{\circ}C$ | | 1900 | A | |
| T_j | | | -40 ... 150 | $^{\circ}C$ | |
| Freewheeling diode | | | | | |
| I_F | $T_j = 150^{\circ}C$ | $T_c = 25^{\circ}C$ | 373 | A | |
| | | $T_c = 80^{\circ}C$ | 258 | A | |
| I_{Fnom} | | | 300 | A | |
| I_{FRM} | $I_{FRM} = 2 \times I_{Fnom}$ | | 600 | A | |
| I_{FSM} | $t_p = 10 ms, \sin 180^{\circ}, T_j = 25^{\circ}C$ | | 1900 | A | |
| T_j | | | -40 ... 150 | $^{\circ}C$ | |
| Module | | | | | |
| $I_{t(RMS)}$ | $T_{terminal} = 80^{\circ}C$ | | 600 | A | |
| T_{stg} | | | -40 ... 125 | $^{\circ}C$ | |
| V_{isol} | AC sinus 50Hz, $t = 1 min$ | | 4000 | V | |

| Characteristics | | | | | | |
|-----------------|--|----------------------|------|----------|------------|------|
| Symbol | Conditions | | min. | typ. | max. | Unit |
| IGBT | | | | | | |
| $V_{CE(sat)}$ | $I_C = 300 A$ $V_{GE} = 15 V$ chipllevel | $T_j = 25^{\circ}C$ | 1.7 | 2.1 | V | |
| | | $T_j = 125^{\circ}C$ | 2.0 | 2.45 | V | |
| V_{CE0} | | $T_j = 25^{\circ}C$ | 1 | 1.2 | V | |
| | | $T_j = 125^{\circ}C$ | 0.9 | 1.1 | V | |
| r_{CE} | $V_{GE} = 15 V$ | $T_j = 25^{\circ}C$ | 2.3 | 3.0 | m Ω | |
| | | $T_j = 125^{\circ}C$ | 3.7 | 4.5 | m Ω | |
| $V_{GE(th)}$ | $V_{GE} = V_{CE}, I_C = 12 mA$ | | 5 | 5.8 | 6.5 | V |
| I_{CES} | $V_{GE} = 0 V$ $V_{CE} = 1200 V$ | $T_j = 25^{\circ}C$ | 0.1 | 0.3 | mA | |
| | | $T_j = 125^{\circ}C$ | | | mA | |
| C_{ies} | $V_{CE} = 25 V$ $V_{GE} = 0 V$ | $f = 1 MHz$ | 21.5 | nF | | |
| C_{oes} | | $f = 1 MHz$ | 1.13 | nF | | |
| C_{res} | | $f = 1 MHz$ | 0.98 | nF | | |
| Q_G | $V_{GE} = -8 V \dots +15 V$ | | 2400 | nC | | |
| R_{Gint} | $T_j = 25^{\circ}C$ | | 2.50 | Ω | | |

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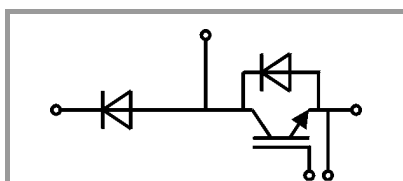
Typical Applications*

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Remarks

- Case temperatur limited to $T_C=125^\circ\text{C}$ max.
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| Characteristics | | | | | | |
|--------------------|--|---------------------------|------|----------------|-------|---------------|
| Symbol | Conditions | | min. | typ. | max. | Unit |
| $t_{d(on)}$ | $V_{CC} = 600\text{ V}$ $I_C = 300\text{ A}$ | $T_j = 125^\circ\text{C}$ | | 280 | | ns |
| t_r | $V_{GE} = \pm 15\text{ V}$ | $T_j = 125^\circ\text{C}$ | | 65 | | ns |
| E_{on} | $R_{G\ on} = 2\ \Omega$ | $T_j = 125^\circ\text{C}$ | | 35 | | mJ |
| $t_{d(off)}$ | $R_{G\ off} = 2\ \Omega$ | $T_j = 125^\circ\text{C}$ | | 630 | | ns |
| t_f | | $T_j = 125^\circ\text{C}$ | | 130 | | ns |
| E_{off} | | $T_j = 125^\circ\text{C}$ | | 45 | | mJ |
| $R_{th(j-c)}$ | per IGBT | | | | 0.083 | K/W |
| Inverse diode | | | | | | |
| $V_F = V_{EC}$ | $I_F = 300\text{ A}$ $V_{GE} = 0\text{ V}$ chip | $T_j = 25^\circ\text{C}$ | | 1.6 | 1.80 | V |
| | | $T_j = 125^\circ\text{C}$ | | 1.6 | 1.8 | V |
| V_{F0} | | $T_j = 25^\circ\text{C}$ | 0.9 | 1 | 1.1 | V |
| | | $T_j = 125^\circ\text{C}$ | 0.7 | 0.8 | 0.9 | V |
| r_F | | $T_j = 25^\circ\text{C}$ | 1.7 | 2.0 | 2.3 | m Ω |
| | | $T_j = 125^\circ\text{C}$ | 2.3 | 2.7 | 3.0 | m Ω |
| I_{RRM} | $I_F = 300\text{ A}$ | $T_j = 125^\circ\text{C}$ | | 375 | | A |
| Q_{rr} | $di/dt_{off} = 6200\text{ A}/\mu\text{s}$ $V_{GE} = -15\text{ V}$ | $T_j = 125^\circ\text{C}$ | | 75 | | μC |
| E_{rr} | $V_{CC} = 600\text{ V}$ | $T_j = 125^\circ\text{C}$ | | 33 | | mJ |
| $R_{th(j-c)}$ | per diode | | | | 0.15 | K/W |
| Freewheeling diode | | | | | | |
| $V_F = V_{EC}$ | $I_F = 300\text{ A}$ $V_{GE} = 0\text{ V}$ chip | $T_j = 25^\circ\text{C}$ | | 1.7 | 1.91 | V |
| | | $T_j = 125^\circ\text{C}$ | | 1.7 | 1.9 | V |
| V_{F0} | | $T_j = 25^\circ\text{C}$ | 0.9 | 1 | 1.1 | V |
| | | $T_j = 125^\circ\text{C}$ | 0.7 | 0.8 | 0.9 | V |
| r_F | | $T_j = 25^\circ\text{C}$ | 1.9 | 2.3 | 2.7 | m Ω |
| | | $T_j = 125^\circ\text{C}$ | 2.7 | 3.1 | 3.5 | m Ω |
| I_{RRM} | $I_F = 300\text{ A}$ | $T_j = 125^\circ\text{C}$ | | 375 | | A |
| Q_{rr} | $di/dt_{off} = 6200\text{ A}/\mu\text{s}$ $V_{GE} = -15\text{ V}$ | $T_j = 125^\circ\text{C}$ | | 75 | | μC |
| E_{rr} | $V_{CC} = 600\text{ V}$ | $T_j = 125^\circ\text{C}$ | | 33 | | mJ |
| $R_{th(j-c)}$ | per diode | | | | 0.15 | K/W |
| Module | | | | | | |
| L_{CE} | | | | 18 | | nH |
| $R_{CC+EE'}$ | res., terminal-chip | $T_C = 25^\circ\text{C}$ | | 0.7 | | m Ω |
| | | $T_C = 125^\circ\text{C}$ | | 1 | | m Ω |
| $R_{th(c-s)}$ | per module | | | 0.045 | | K/W |
| M_s | to heat sink (M5) | | 3 | | 5 | Nm |
| M_t | | to terminals (M6) | 2.5 | | 5 | Nm |
| | | | | | | Nm |
| w | | | | | 250 | g |
| Temperatur Sensor | | | | | | |
| R_{100} | $T_C = 100^\circ\text{C}$ ($R_{25} = 5\text{ k}\Omega$) | | | $493 \pm 5\%$ | | Ω |
| $B_{100/125}$ | $R_{(T)} = R_{100} \exp[B_{100/125}(1/T - 1/T_{100})]$; $T[K]$; | | | $3550 \pm 2\%$ | | K |



GAL

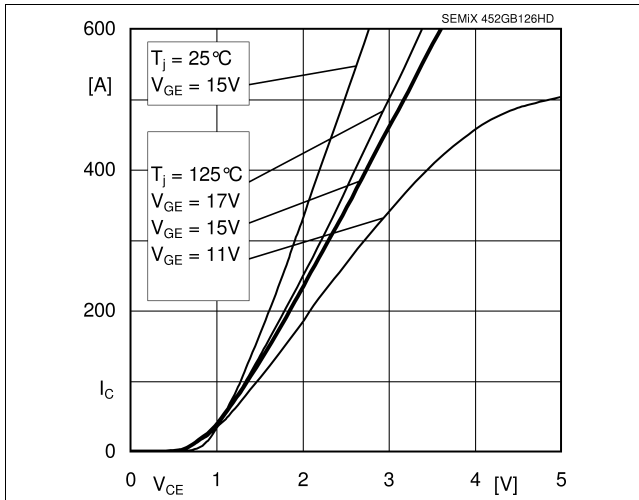


Fig. 1: Typ. output characteristic, inclusive $R_{CC}'+E_E$

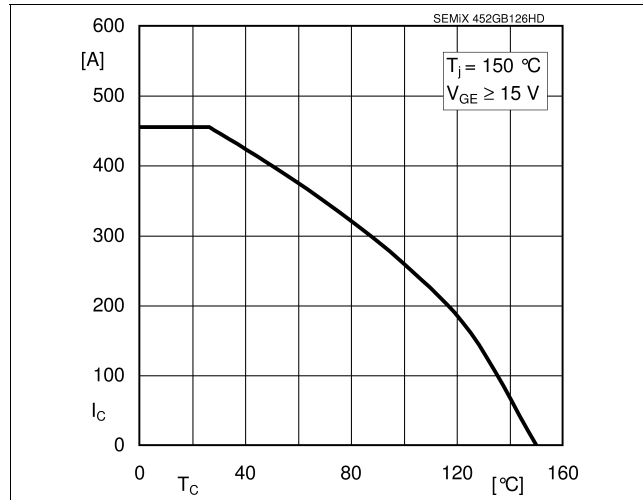


Fig. 2: Rated current vs. temperature $I_C = f(T_C)$

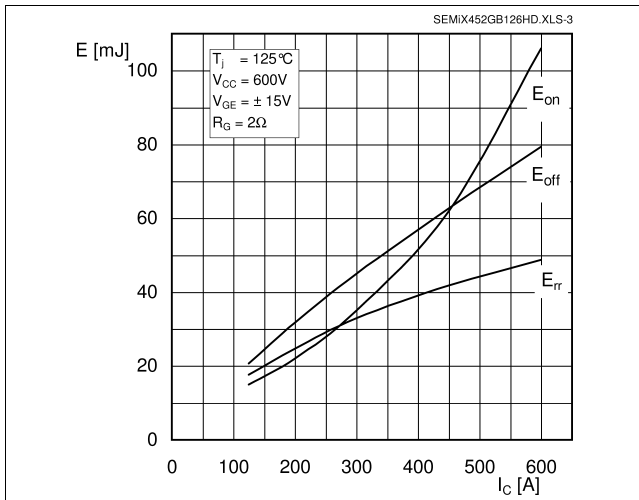


Fig. 3: Typ. turn-on /-off energy = $f(I_C)$

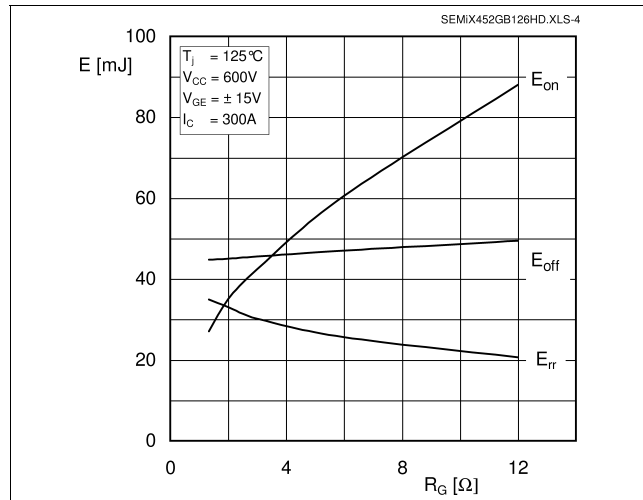


Fig. 4: Typ. turn-on /-off energy = $f(R_G)$

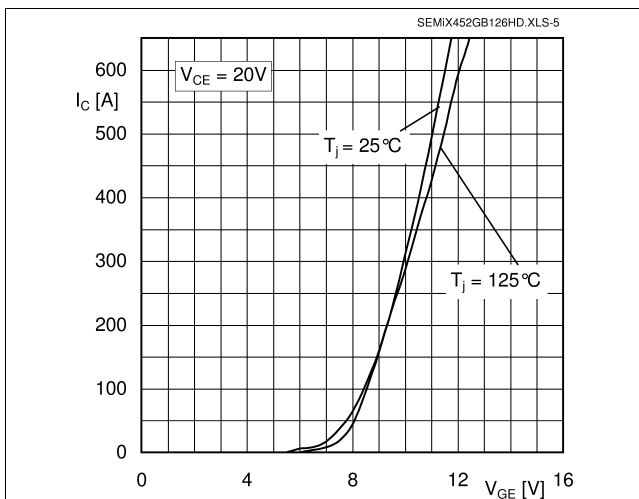


Fig. 5: Typ. transfer characteristic

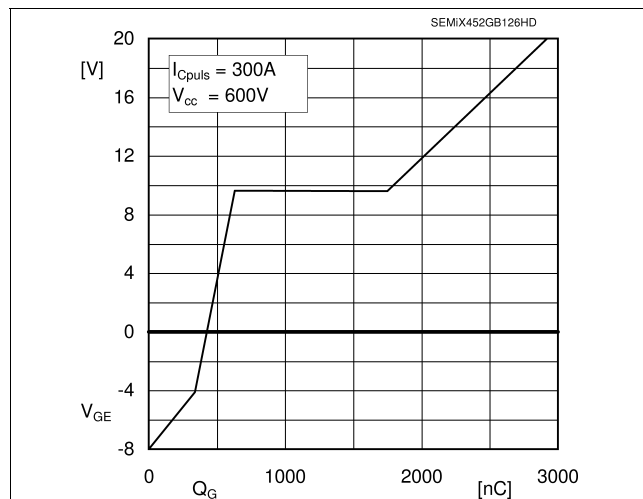


Fig. 6: Typ. gate charge characteristic

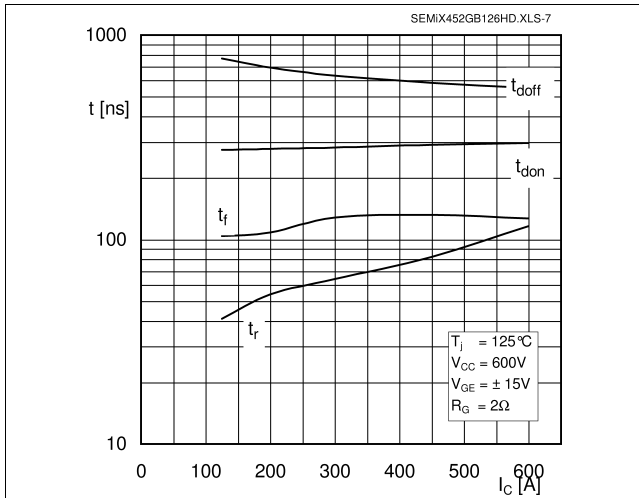


Fig. 7: Typ. switching times vs. I_C

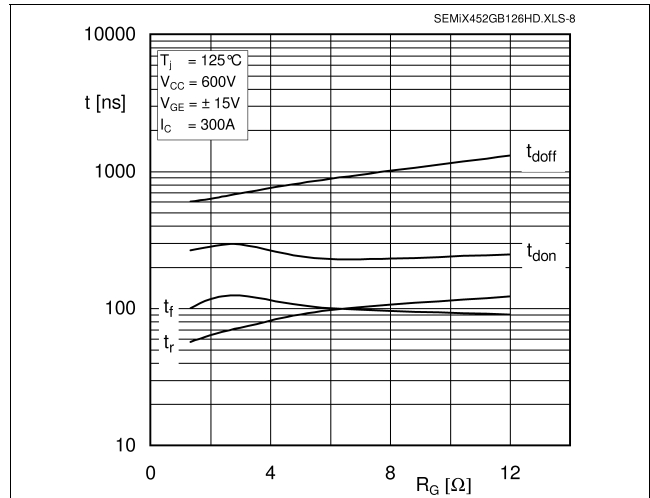


Fig. 8: Typ. switching times vs. gate resistor R_G

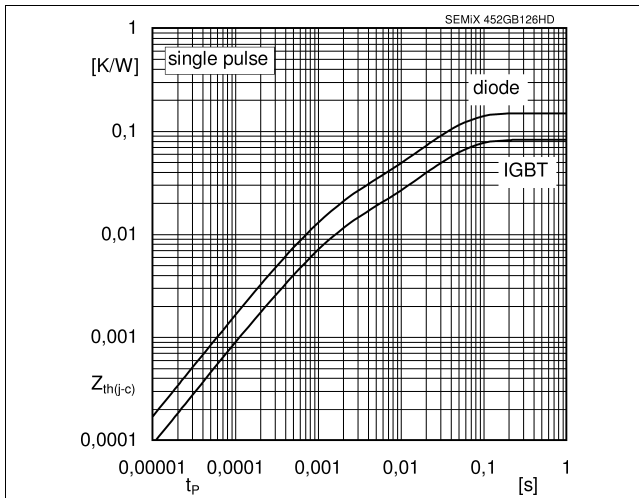


Fig. 9: Typ. transient thermal impedance

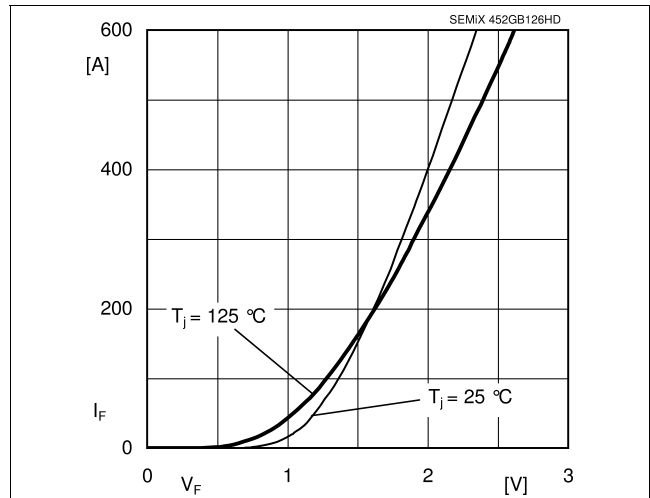


Fig. 10: Typ. CAL diode forward charact., incl. R_{CC+EE}

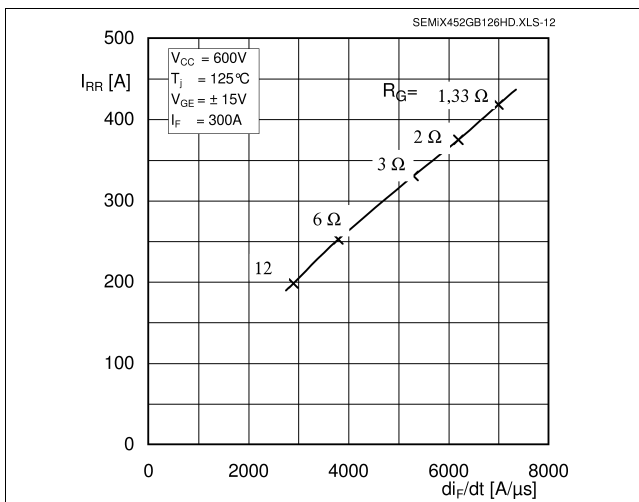


Fig. 11: Typ. CAL diode peak reverse recovery current

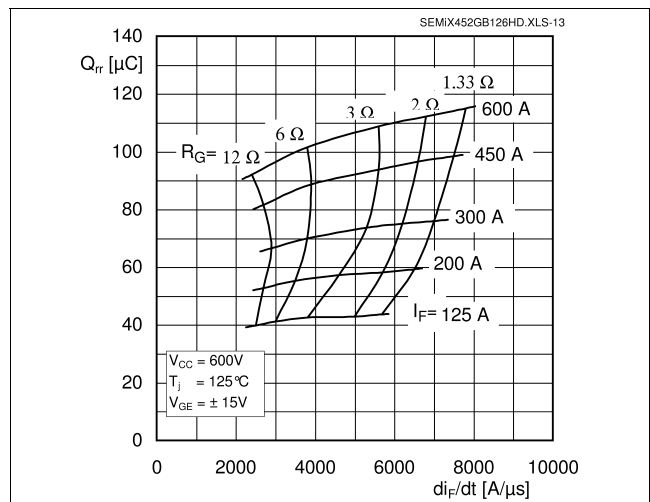


Fig. 12: Typ. CAL diode recovery charge

